

HEAd'18: Call for Papers

4th International Conference on Higher Education Advances

June 20 - 22, 2018. Valencia, Spain

<http://www.headconf.org>

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Scope

After the great success of the previous HEAd conferences, which received submissions from 51 countries, we are pleased to announce the Fourth International Conference on **Higher Education Advances** (HEAd'18). This conference is an excellent forum for researchers and practitioners to exchange ideas, experiences, opinions and research results relating to the preparation of students, teaching/learning methodologies and the organization of educational systems.

The HEAd'18 conference will be held on June 20-22, 2018 at the Faculty of Business Administration and Management of the Universitat Politècnica de València (UPV), which has been recently ranked as the best technical university in Spain by the Academic Ranking of World Universities (ARWU) 2017.

Topics of interest

The program committee encourages the submission of articles that communicate applied and empirical findings of interest to higher education professionals. Topics of interest include, but are not limited to, the following topic areas:

- Innovative materials and new tools for teaching
- Teaching and learning experiences
- Educational technology (e.g., virtual labs, e-learning)
- Evaluation and assessment of student learning
- Emerging technologies in learning (e.g., MOOC, OER, gamification)
- Experiences outside the classroom (e.g., practicums, mobility)
- New teaching/learning theories and models
- Globalization in education and education reforms
- Education economics
- Learning for employment
- Education accreditation, quality and assessment
- Competency-based learning and skill assessment

Important Dates

Submission deadline: February 9, 2018

Author notification: April 11, 2018

Camera ready due: April 30, 2018

Conference dates: June 20-22, 2018

Publications

All accepted papers will appear in the conference proceedings with a DOI and ISBN number. They will be published in open access by UPV Press and submitted to be indexed in major international bibliographic databases. Previous editions are indexed in the Thomson-Reuters Conference Proceedings Citation Index - **Web of Science** Core Collection (former ISI Proceedings).

Awards

The Program Committee will select the winners for the Best Paper and Best Student Paper awards. To be eligible for the best student paper award, the presenting author of the paper must be a full-time student.

Submission guidelines

Authors from all over the world are invited to submit original and unpublished papers, which are not under review in any other conference or journal. All papers will be peer reviewed by the program committee based on their originality, significance, methodological soundness, and clarity of exposition.

Submitted papers must be written in English and should be in PDF format. They must follow the instructions in the template file, available in Microsoft Word format at:

<http://www.headconf.org/template.docx>

Paper length must be between 4 and 8 pages, incorporating all text, references, figures and tables. These guidelines are strict: papers failing to adhere to the guidelines will be rejected without consideration of their merits. Submissions imply the willingness of at least one author to register, attend the conference, and present the paper.

HEAd'18 is using the OCS platform of UPV Press to manage the submissions. This platform provides you with a submissions homepage where you can register your paper submission and make appropriate changes. The submission website is:

<http://www.headconf.org/submission-instructions/>

About the venue

Valencia is the third largest city in Spain and is located on the shore of the Mediterranean Sea. It embraces culture and tradition from the past combined with singular architecture, exciting gastronomy, nightlife, and beautiful white sand beaches. Valencia is the capital city of the Comunitat Valenciana region, which is major tourist destination in summer. More info at:

<http://www.headconf.org/venue/about-valencia/>

The organizing committee looks forward to welcoming you all to a fruitful conference with open discussions and important networking to promote high quality education.

